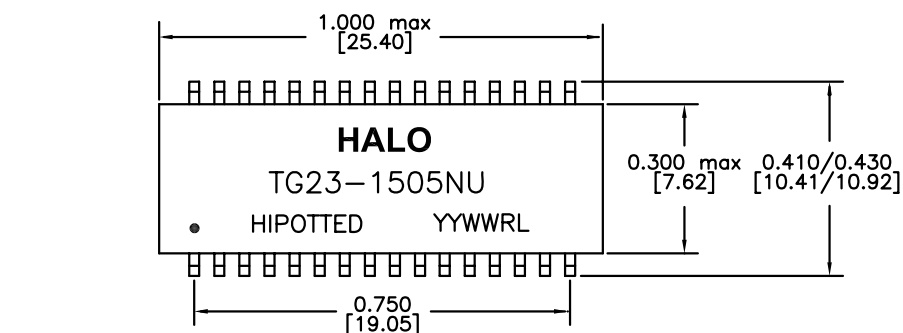
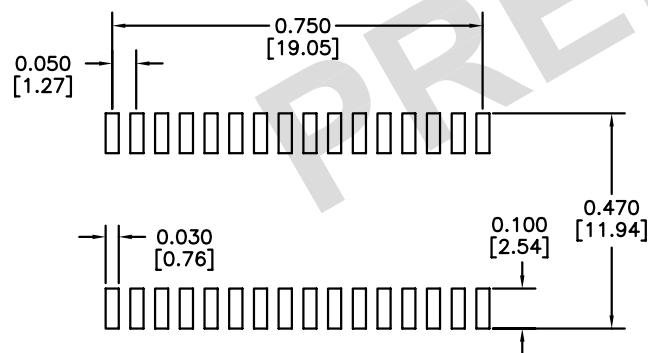


DIMENSIONS: Inch [mm]
CO-PLANARITY: 0.004 [0.10]
TOLERANCES: ±0.005 INCH IF NOT SPECIFIED



RECOMMENDED SOLDER PAD DIMENSIONS



PART NO. : TG23-1505NURL

32PIN "MINI OCTAL" T1/E1 ISOLATION MODULE
RoHS COMPLIANT

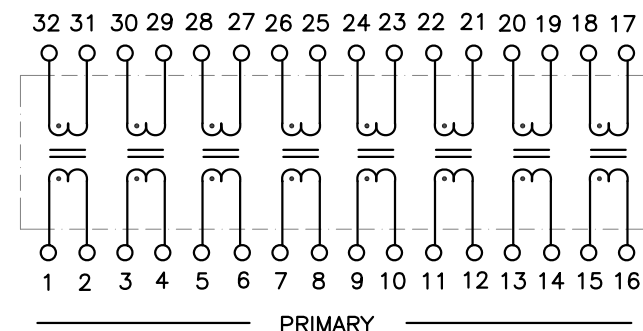
COMPATIBLE TO LEAD-FREE SOLDERING PROCESS
CONDITION PER IPC/JEDEC J-STD-020C

UL/EN60950 AND DEMKO RECOGNIZED

EXTENDED OPERATING TEMPERATURE -40/+85°C

ELECTRICAL SPECIFICATIONS @25° C

URNS RATIO	
RPI:SEC	1:2.42 ±2%
OCL (PRIMARY)	1.5mH typ
DCR (PRIMARY)	0.8Ω max
LL (PRIMARY)	0.5μH max
Cw/w	35pF max
CROSSTALK 0.5-5MHz	-60dB typ
ISOLATION	1,500Vrms



HALO/PBL

TITLE OCTAL ISOLATION MODULE
FOR T1/E1 (1:2.42 TURNS RATIO)
PART NO. TG23-1505NURL

SCALE NONE PAGE 1 OF 1

SIGNATURES	DATE	REV.	DESC.	DATE
DRAWN PETER LU	12/30/08	A	FIRST ISSUE	12/30/08
CHECKED LEI KEONG	12/30/08			
APPROVED PETER LU	12/30/08			
FILE 1505NURL.DWG				

CALIFORNIA, USA
KOWLOON, HONG KONG
SINGAPORE